

STL105DN4LF7AG

Automotive-grade dual N-channel 40 V, 3.5 mΩ typ., 40 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 DI

Datasheet - production data

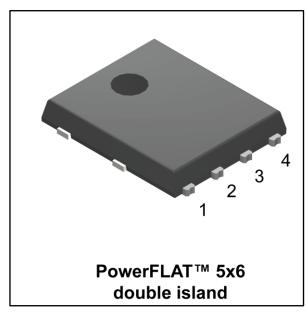
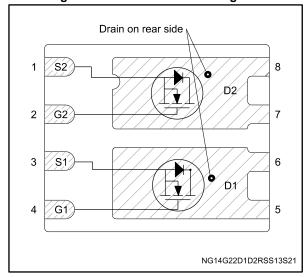


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STL105DN4LF7AG	40 V	4.5 mΩ	40 A



- AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

Applications

• Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packing
STL105DN4LF7AG	105DN4L	PowerFLAT™ 5x6 double island	Tape and reel

January 2018 DocID031358 Rev 1 1/16

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STL105DN4LF7AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	40	V	
V _{GS}	Gate-source voltage	±20	V	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	40	Α	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	40	Α	
I _{DM} ⁽²⁾	Drain current (pulsed) 160		Α	
Ртот	Total dissipation at T _C = 25 °C	94	W	
Tj	Operating junction temperature range		°C	
T _{stg}	Storage temperature range			

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.6	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	32	°C/W

Notes:

 $^{^{(1)}}$ Drain current is limited by package, the current capability of the silicon is 105 A at 25 °C and 74 A at 100 °C.

⁽²⁾Pulse width limited by safe operating area.

 $^{^{(1)}\!}When$ mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.

Electrical characteristics STL105DN4LF7AG

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On/Off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1$ mA, $V_{GS} = 0$ V	40			V
IDSS	Zero gate voltage drain current	V _{GS} = 0 V V _{DS} = 40 V			10	μΑ
Igss	Gate-body leakage current	V _{GS} = ±20 V, V _{DS} = 0 V			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.5		2.5	V
D-ac	Static drain-source	V _G S = 10 V, I _D = 12 A		3.5	4.5	mΩ
R _{DS(on)}	on-resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 12 \text{ A}$		5.3	8	11177

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1594	ı	
Coss	Output capacitance	$V_{DS} = 25 \text{ V, } f = 1 \text{ MHz,}$	-	415	ı	pF
Crss	Reverse transfer capacitance	V _G S = 0 V	-	48	1	ρı
Qg	Total gate charge	$V_{DD} = 20 \text{ V}, I_D = 24 \text{ A},$	-	27.5	ı	
Q_{gs}	Gate-source charge	$V_{GS} = 0$ to 10 V (see <i>Figure</i>	-	5.5	ı	nC
Q_{gd}	Gate-drain charge	14: "Test circuit for gate charge behavior")	-	6.1	1	

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 32 \text{ V}, I_D = 12 \text{ A},$	-	11	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see	-	8.5	-	
t _{d(off)}	Turn-off delay time	Figure 13: "Test circuit for resistive load switching	ı	48.5	1	ns
t _f	Fall time	times" and Figure 18: "Switching time waveform")	-	15	-	

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		ı		40	Α
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		1		160	Α
V _{SD} ⁽³⁾	Forward on voltage	I _{SD} = 40 A, V _{GS} = 0 V	ı		1.3	V
t _{rr}	Reverse recovery time	$I_{SD} = 24 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	ı	29.3		ns
Qrr	Reverse recovery charge	V _{DD} = 32 V (see Figure 15: "Test circuit	1	22.5		nC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	-	1.5		Α

Notes:

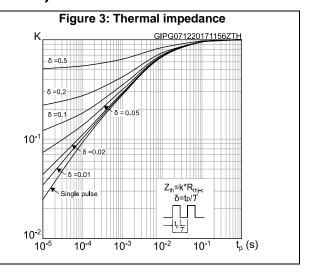
 $^{^{(1)}\}mbox{D}\mbox{rain current}$ is limited by package, the current capability of the silicon is 105 A at 25 °C.

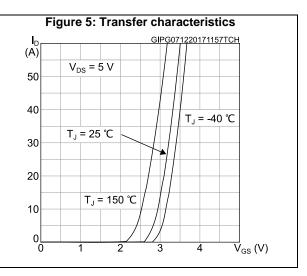
 $[\]ensuremath{^{(2)}}\mbox{Pulse}$ width limited by safe operating area .

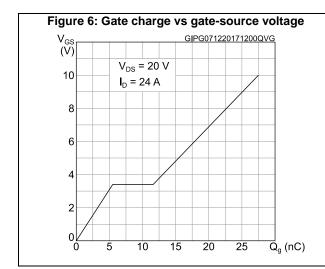
 $^{^{(3)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area GIPG071220171155SOA (A) Operation in this area is limited by R_{DS(on)} 10² 10 t₀=100 µs T_i≤175 °C 10⁰ T_o= 25°C single pulse t =1 ms ˈtೄ=10 ms 10⁻¹ 10° 10¹ $\overline{V}_{DS}(V)$ 10⁻¹







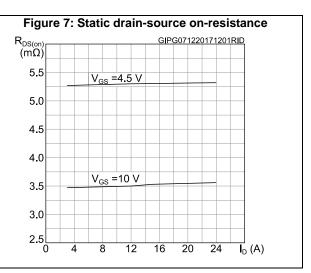


Figure 8: Capacitance variations

C GIPG071220171207CVR
(pF)

103

C CISS

C COSS

104

C CRSS

C CRSS

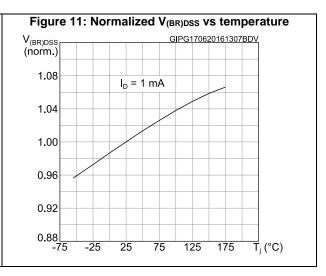
C CRSS

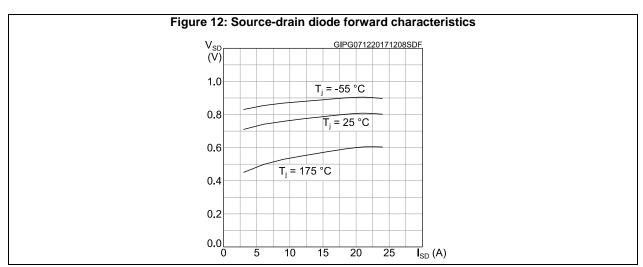
C CRSS

C CRSS

Figure 9: Normalized gate threshold voltage vs temperature V_{GS(th)} (norm.) GIPG170620161302VTH 1.2 $I_D = 250 \, \mu A$ 1.0 0.8 0.6 0.4 0.2 -25 25 75 125 175 T_i (°C)

Figure 10: Normalized on-resistance vs temperature R_{DS(on)} (norm.) GIPG170620161300RON $V_{GS} = 10 V$ 2.0 I_D = 12 A 1.5 1.0 0.5 0.0 -75 $\overline{\mathsf{T}}_{\mathsf{j}}\,(^{\circ}\mathsf{C})$ -25 25 75 125 175





Test circuits STL105DN4LF7AG

3 Test circuits

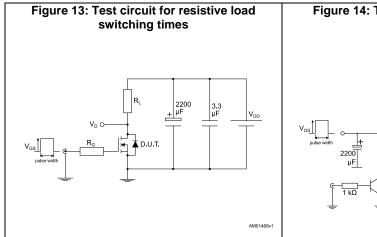


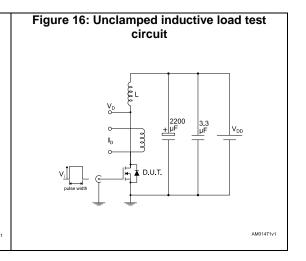
Figure 14: Test circuit for gate charge behavior

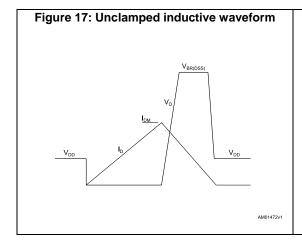
12 V 47 kΩ 100 nF D.U.T.

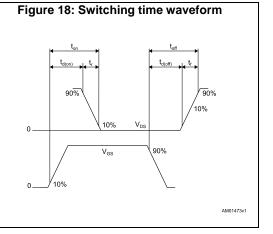
2200 VG

AM01468y1

Figure 15: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 PowerFLAT 5x6 double island WF type C package information

BOTTOM VIEW D3 D6 E8 9 E E7 E4×4 Di2 E3 E2 D7 E3 Din#1 Detail A Scale 3:1 0.08 $\frac{3}{e(x6)} = \frac{2}{e(x6)}$ D5(x4)b (x8)-D4 SIDE VIEW Detail A

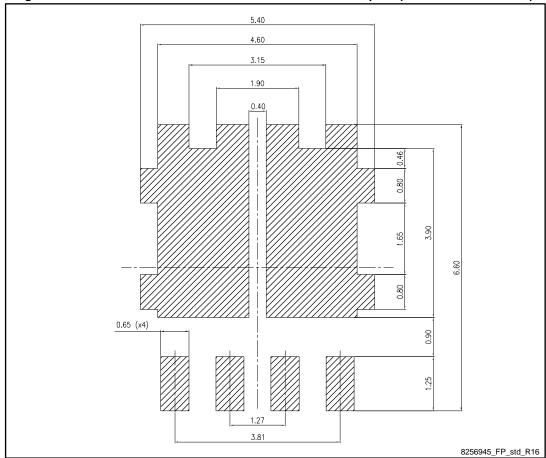
Figure 19: PowerFLAT™ 5x6 double island WF type C package outline

TOP VIEW 826945_DI_WF_typeC_r16

Table 8: PowerFLAT™ 5x6 double island WF type C mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
Α	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
С	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
D7	1.68		1.98
е		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E8	0.55		0.75
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
L	0.90	1.00	1.10
L1	0.175	0.275	0.375
K	1.05		1.35
θ	0°		12°





STL105DN4LF7AG Package information

4.2 Packing information

Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm)

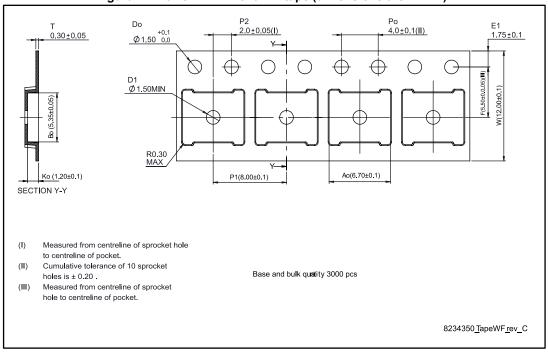
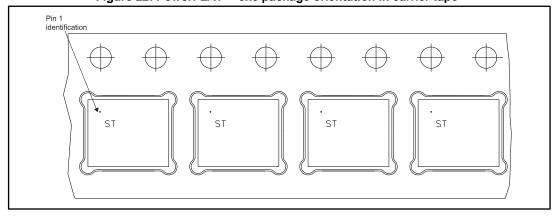


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape



Package information STL105DN4LF7AG

R25.00

Figure 23: PowerFLAT™ 5x6 reel (dimensions are in mm)

STL105DN4LF7AG Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
10-Jan-2018	1	First release.

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